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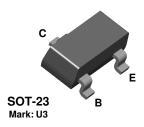
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BSS64



NPN General Purpose Amplifier

This device is designed for general purpose high voltage amplifiers and gas discharge display driving. Sourced from Process 16.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{CEO}	Collector-Emitter Voltage	80	V	
V _{CBO}	Collector-Base Voltage	120	V	
V _{EBO}	Emitter-Base Voltage	5.0	V	
Ic	Collector Current - Continuous	200	mA	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	racteristic Max	
		*BSS64	
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

^{*}Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

NPN General Purpose Amplifier

(continued)

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
055 0114	2407500				
	RACTERISTICS			T	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = 4.0 \text{ mA}, I_B = 0$	80		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	120		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 100 \mu A, I_C = 0$	5.0		V
I _{CBO}	Collector-Cutoff Current	$V_{CB} = 90 \text{ V}, I_{E} = 0$		0.1	μΑ
		$V_{CB} = 90 \text{ V}, I_{E} = 0, T_{A} = 150^{\circ}\text{C}$		50	μΑ
I _{EBO}	Emitter-Cutoff Current	$V_{EB} = 5.0 \text{ V}, I_{C} = 0$		200	nA

ON CHARACTERISTICS

h _{FE}	DC Current Gain	$I_C = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$	20		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 4.0 \text{ mA}, I_B = 400 \mu\text{A}$		0.15	V
		$I_{\rm C} = 50 \text{ mA}, I_{\rm B} = 15 \text{ mA}$		0.2	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 4.0 \text{ mA}, I_B = 400 \mu\text{A}$		1.2	V

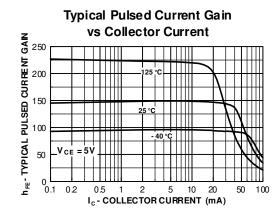
SMALL SIGNAL CHARACTERISTICS

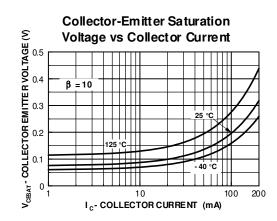
f _T	Current Gain - Bandwidth Product	$I_C = 4.0 \text{ mA}, V_{CE} = 10,$ f = 35 MHz	60		MHz
C _{ob}	Output Capacitance	$V_{CB} = 10 \text{ V}, f = 1.0 \text{ MHz}$		5.0	pF

Spice Model

 $NPN \ (Is=2.511f \ Xti=3 \ Eg=1.11 \ Vaf=100 \ Bf=242.6 \ Ne=1.249 \ Is=2.511f \ Ikf=.3458 \ Xtb=1.5 \ Br=3.197 \ Nc=2 \ Isc=0 \ Ikr=0 \ Rc=1 \ Cjc=4.883p \ Mjc=.3047 \ Vjc=.75 \ Fc=.5 \ Cje=18.79p \ Mje=.3416 \ Vje=.75 \ Tr=1.202n \ Tf=560p \ Itf=50m \ Vtf=5 \ Xtf=8 \ Rb=10)$

Typical Characteristics



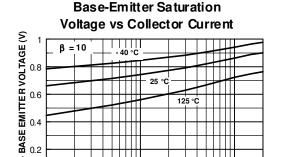


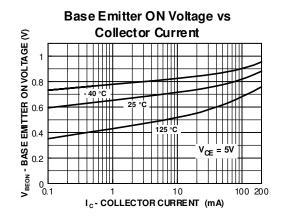
NPN General Purpose Amplifier

(continued)

Typical Characteristics

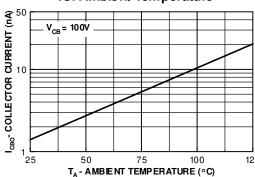
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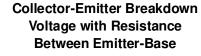


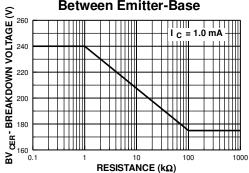




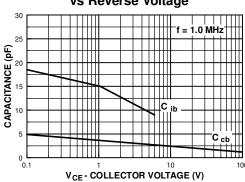
I_C - COLLECTOR CURRENT (mA)



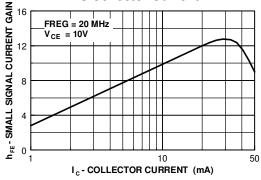




Input and Output Capacitance vs Reverse Voltage



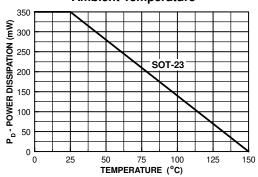
Small Signal Current Gain vs Collector Current



NPN General Purpose Amplifier (continued)

Typical Characteristics (continued)





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